# Hanumath Sreeman Vedantham

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Vijayawada, Kanchipuram

#### **EDUCATION**

# Bachelor of Engineering (B.E), Computer Science & Engineering

Sri Chandrasekharendra Saraswathi Viswa Mahavidyalaya University (SCSVMV)

2017 - 2021 CGPA: 8.78/10

# Senior Secondary (XII), Science

Narayana College

(AP STATE BOARD board) Year of completion: 2017

CGPA: 9.00/10

# Secondary (X)

Sri Vignana Vihara

(AP STATE BOARD board) Year of completion: 2015

CGPA: 8.70/10

#### **INTERNSHIPS**

# **Database Building/Management**

Karvy Insurance Repository, Hyderabad

Sep 2019 - Oct 2019

Database management

# TRAININGS

# **Machine Learning**

Coursera, Online Mar 2020 - Jun 2020

### **Data Science**

Verzeo, Online

Mar 2020 - May 2020

I have taken a month training on Data Science. And I have completed 1 major and 1 minor projects

# **Introduction To Structured Query Language**

Courseera, Online Oct 2019 - Oct 2019

## **Python Programming For Master Class**

udemy, Online

Jan 2019 - Apr 2019

## **PROJECTS**

## Women's Clothing E-Commerce Reviews

May 2020 - May 2020

I have created a machine learning model to predict whether the review of a product is either good or bad using Natural Language Processing (NLP) techniques.

# **CSE Department Website**

Mar 2020 - Present

SKILLS C Programming C++ Programming

Intermediate Intermediate

Data StructuresAlgorithmsIntermediateIntermediate

HTML CSS

Intermediate Intermediate

Database Management System (DBMS) Python Intermediate

Intermediate

Java Machine Learning

Beginner Intermediate

Natural Language Processing (NLP)

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Beginner

Beginner

WORK SAMPLES GitHub profile

https://github.com/hanumathvedantham

Other portfolio link

https://hanumathvedantham.github.io/portifolio/index.html

ADDITIONAL DETAILS Presented a paper on the topic "Product Recommendation Systems Based On

Customer Reviews Using Machine Learning Techniques" in the International Conference in July 2020 (ICDICI 2020). The proceedings of the conference will be

published in Springer.